FORM **PTO-1595** (modified) (Rev. 6-93)

OMB No. 0651-0011 (exp. 4/94)

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1. Name of conveying party(ies):

Myung Sup JUNG, Jong Jin PARK, Sung Ouk JUNG, Seung Joo

Additional name(s) of conveying party(ies) attached? No

SEO, Bon Won KOO

3. Nature of conveyance:

Assignment

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Execution Date: October 29, 2003 and November 3, 2003

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

10/693,647

B. Patent No.(s)

Additional numbers attached? No

5. Name and address of party to whom correspondence concerning

document should be mailed:

Name: Eugene M. Lee

Internal Address: LEE & STERBA, P.C.

Street Address: 1101 Wilson Boulevard, Suite 2000

City: Arlington, State: VA ZIP: 22209

6. Total number of applications and patents involved: **One** 

Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.

Additional name(s) & address(es) attached? No

Street Address: 416 Maetan-dong, Yeongtong-gu, City: Suwon-si, Gyeonggi-do, REPUBLIC OF KOREA

Internal Address:

7. Total fee (37 C.F.R., 3.41). . . . . . \$40.00

Enclosed

X Authorized to be charged to deposit account

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

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April 1, 2004 Date

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PATENT

REEL: 015168 FRAME: 0798

<b>ASSIGNMEN</b>	Δ	S	ST	G	N	M	F	N	1
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name and address of assignee	For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor has sold and assigned, and by these presents hereby sells and assigns, unto SAMSUNG ELECTRONICS CO., LTD.  416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea
	(hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to his invention relating to
title of invention	METHOD FOR LAMINATING AND PATTERNING CARBON NANOTUBES USING CHEMICAL SELE ASSEMBLY PROCESS

	as set forth in this United States Patent Application	
check one	X executed concurrently herewith	
	executed on	
	Serial No Filed	

in and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States which may issue on any such application or for said invention, including any and all reissues or extensions thereof, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he has the full and unencumbered right to sell and assign the interests herein sold and assigned and that he has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees he will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said invention or patent application and that he will execute and deliver any papers, make all rightful oaths, testify in any legal proceedings and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to perfect title to said invention, to said application including divisions and continuations thereof and to any and all Letters Patent which may be granted therefor or thereon, including reissues or extensions, in said ASSIGNEE, its successors, or assigns or to assist said ASSIGNEE, its successors, legal representatives or assigns in obtaining, reissuing or enforcing Letters Patent of the United States for said invention;

Each of the undersigned hereby grants the firm of **LEE & STERBA**, **P.C.** the power to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment.

NAMES AND SIGNATURES OF INVENTORS						
Name: Myung Sup JUNG	Signature: Lett	Date: 3/Alev / 2003				
Name: Jong Jin PARK	Signature: 200000	Date: 29/0ct/2003				
Name: Sung Ouk JUNG	Signature:	Date: 3/1/04 /2003				
Name: Seung Joo SEO	Signature: Signature:	Date: 3/11 ( >= 3)				
Name: Bon Won KOO	Signature: 7127	Date: 3/11 /2003				
NAMES AND SIGNATURES OF WITNESSES						
Name: Youn Hee KIM Name: Eun Ju SON	Signature:	Date: Nov. 6, 2003				

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PATENT RECORDED: 04/01/2004 REEL: 015168 FRAME: 0799